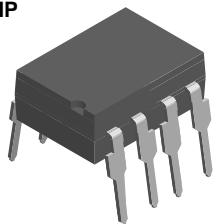
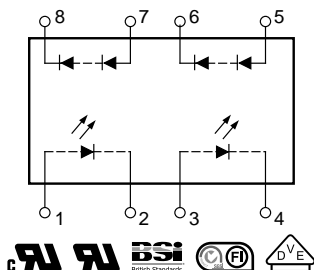
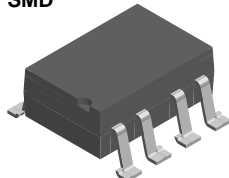


Dual Photovoltaic MOSFET Driver Solid-State Relay

DIP



SMD



FEATURES

- High open circuit voltage
- High short circuit current
- Isolation test voltage 5300 V_{RMS}
- Logic compatible input
- High reliability
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

APPLICATIONS

- High-side driver
- Solid-state relays
- Floating power supply
- Power control
- Data acquisition
- ATE
- Isolated switching

AGENCY APPROVALS

- [UL1577](#)
- [DIN EN](#)
- [BSI](#)
- [CQC](#)
- [FIMKO](#)

DESIGN SUPPORT TOOLS

[click logo to get started](#)



3D
Models
Available

Related
Documents

DESCRIPTION

The LH1262CB, LH1262CAC photovoltaic MOSFET driver consists of two LEDs optically coupled to two photodiode arrays. The photodiode array provides a floating source with adequate voltage and current to drive high-power MOSFET transistors. Optical coupling provides a high I/O isolation voltage. In order to turn the MOSFET off, an external resistance (gate-to-source) is required for gate discharge.

ORDERING INFORMATION

<div><div>L</div><div>H</div><div>1</div><div>2</div><div>6</div><div>2</div><div>#</div><div>#</div><div>#</div><div>T</div><div>R</div></div> <div><div><div><div></div><div></div><div></div><div></div><div></div><div></div><div></div><div></div><div></div><div></div><div></div></div><div>PART NUMBER</div></div><div><div><div></div><div></div><div></div></div><div>ELECTR. VARIATION</div></div><div><div><div></div><div></div><div></div></div><div>PACKAGE CONFIG.</div></div><div><div><div></div><div></div><div></div></div><div>TAPE AND REEL</div></div><div><div><div>DIP</div><div></div></div></div><div><div><div>SMD</div><div></div></div></div></div>	
<div><div>PACKAGE</div><div>SMD-8</div><div>SMD-8, tape and reel</div><div>DIP-8</div></div>	<div><div>UL, VDE, BSI, CQC, FIMKO</div><div>LH1262CAC</div><div>LH1262CACTR</div><div>LH1262CB</div></div>

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
SSR				
LED input ratings continuous forward current		I _F	50	mA
LED input ratings reverse voltage	I _R ≤ 10 μA	V _R	5.0	V
Ambient operating temperature range		T _{amb}	-40 to +85	°C
Storage temperature range		T _{stg}	-40 to +150	°C
Pin soldering time	t = 7.0 s max.	T _s	270	°C

Note

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability

**ELECTRICAL CHARACTERISTICS** ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
LED forward voltage	$I_F = 10\text{ mA}$	V_F	1.15	1.26	1.45	V
Detector forward voltage	$I_F = 10\text{ }\mu\text{A}$	$V_{F(PDA)}$	-	14	-	V
Detector reverse voltage	$I_R = 2.0\text{ }\mu\text{A}$	$V_{R(PDA)}$	-	200	-	V
Open circuit voltage (pins 5, 6 or 7, 8)	$I_F = 5.0\text{ mA}$	V_{OC}	10	12.95	15	V
	$I_F = 10\text{ mA}$	V_{OC}	-	13.45	-	V
	$I_F = 20\text{ mA}$	V_{OC}	-	13.92	-	V
Short circuit current (pins 5, 6 or 7, 8)	$I_F = 5.0\text{ mA}$	I_{SC}	1.0	1.6	6.5	μA
	$I_F = 10\text{ mA}$	I_{SC}	2.6	3.4	14	μA
	$I_F = 20\text{ mA}$	I_{SC}	-	6.9	-	μA

Note

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements

SWITCHING CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Turn-on time	$I_F = 20\text{ mA}$ ⁽¹⁾	t_{on}	-	35	-	μs
Turn-off time	$I_F = 20\text{ mA}$ ⁽¹⁾	t_{off}	-	90	-	μs

Note

- ⁽¹⁾ $f = 1.0\text{ kHz}$, pulse width = $100\text{ }\mu\text{s}$, load (R_L) = $1.0\text{ M}\Omega$, 15 pF ; measured at 90 % rated voltage (t_{on}), 10 % rated voltage (t_{off}). Actuation speed depends upon the external t_{on} and t_{off} circuitry and the capacitance of the MOSFET

SAFETY AND INSULATION RATINGS

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		40 / 85 / 21	
Pollution degree	According to DIN VDE 0109		2	
Comparative tracking index	Insulation group IIIa	CTI	175	
Maximum rated withstanding isolation voltage	According to UL1577, $t = 1\text{ min}$	V_{ISO}	5300	V_{RMS}
Tested withstanding isolation voltage	According to UL1577, $t = 1\text{ s}$	V_{ISO}	4420	V_{RMS}
Maximum transient isolation voltage	According to DIN EN 60747-5-5	V_{IOTM}	8000	V_{peak}
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5	V_{IORM}	890	V_{peak}
Isolation resistance	$V_{IO} = 500\text{ V}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$	R_{IO}	$\geq 10^{12}$	Ω
	$V_{IO} = 500\text{ V}$, $T_{amb} = 100\text{ }^{\circ}\text{C}$	R_{IO}	$\geq 10^{11}$	Ω
	$V_{IO} = 500\text{ V}$, $T_{amb} = T_S$	R_{IO}	$\geq 10^9$	Ω
Output safety power		P_{SO}	700	mW
Input safety current		I_{SI}	300	mA
Safety temperature		T_S	175	$^{\circ}\text{C}$
Creepage distance (DIP)	DIP-8		≥ 7	mm
Clearance distance (DIP)			≥ 7	mm
Creepage distance (SMD)	SMD-8		≥ 8	mm
Clearance distance (SMD)			≥ 8	mm
Insulation thickness		DTI	≥ 0.4	mm

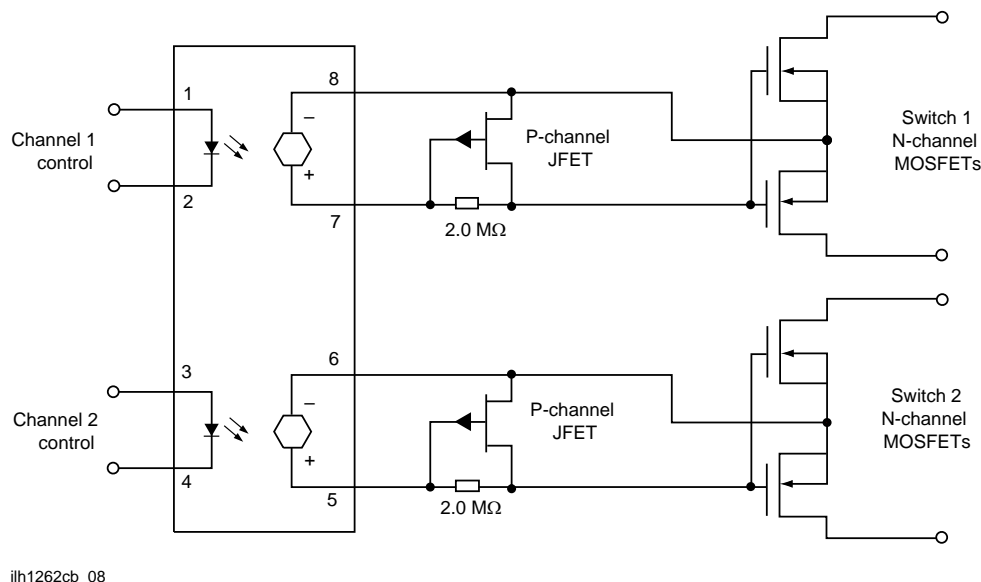
Note

- As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits

FUNCTIONAL DESCRIPTION

Figure 1 outlines the IV characteristics of the illuminated photodiode array (PDA). For operation at voltages below V_{OC} , the PDA acts as a nearly constant current source. The actual region of operation depends upon the load.

The amount of current applied to the LED (pins 1 and 2 or 3 and 4) determines the amount of light produced for the PDA. For high temperature operation, more LED current may be required.



ilh1262cb_08

Fig. 1 - Typical Dual Form A Solid-State Relay Application

PACKAGE DIMENSIONS (in millimeters)

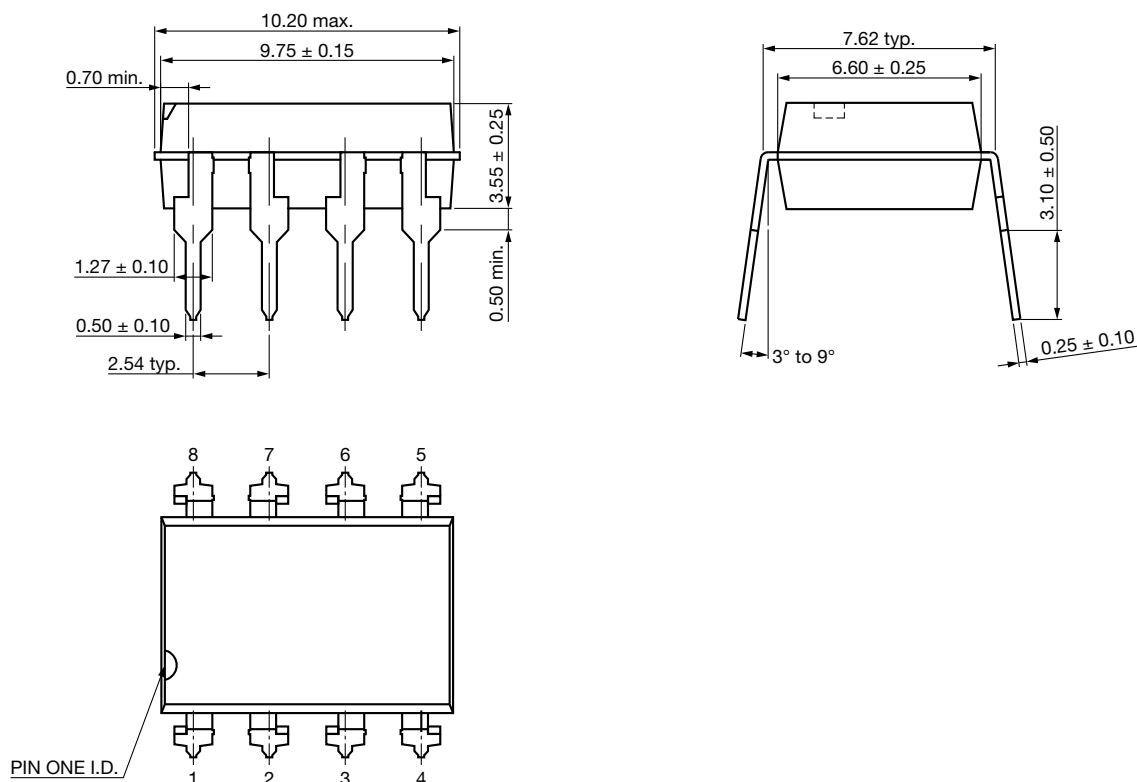


Fig. 2 - DIP-8 Package Drawing

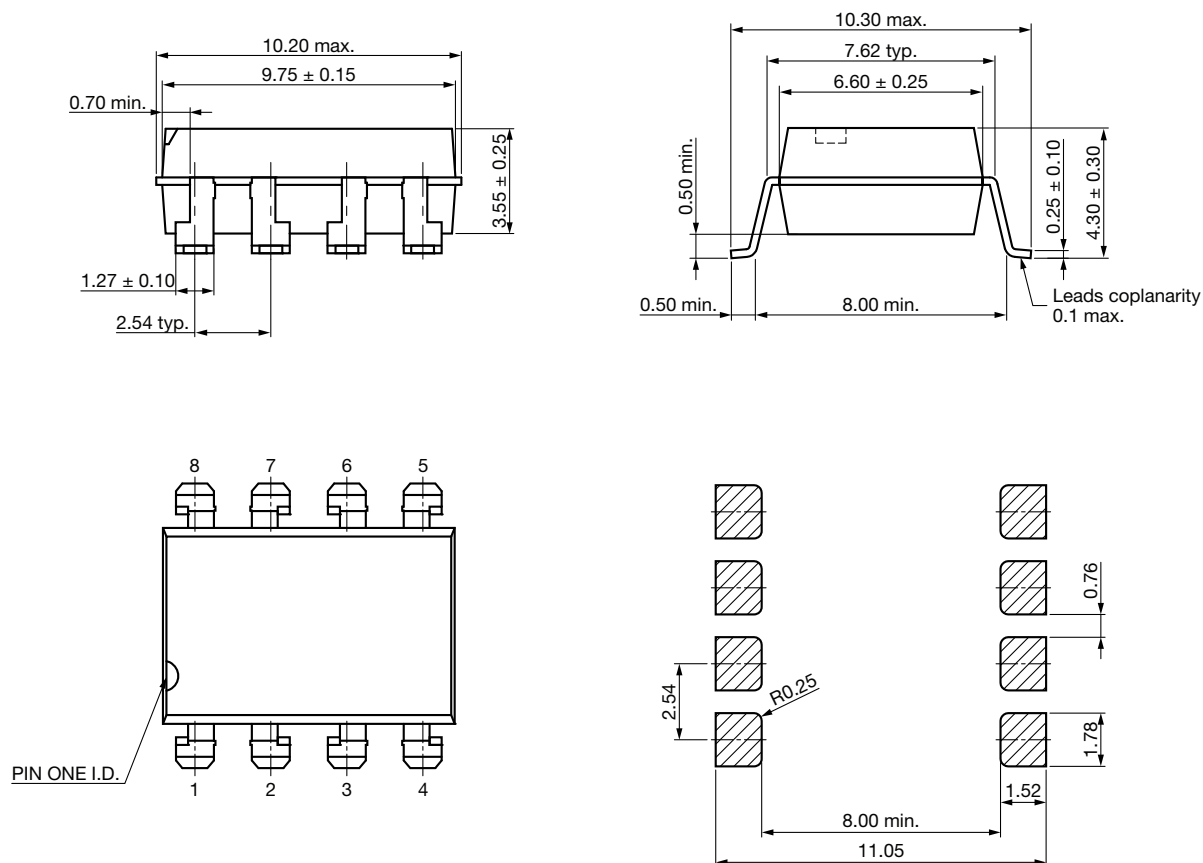


Fig. 3 - SMD-8 Package Drawing

PACKAGE MARKING (example)

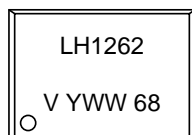


Fig. 4 - LH1262

Notes

- VDE logo is only marked on option 1 parts
- Tape and reel suffix (T) is not part of the package marking



SOLDER PROFILES

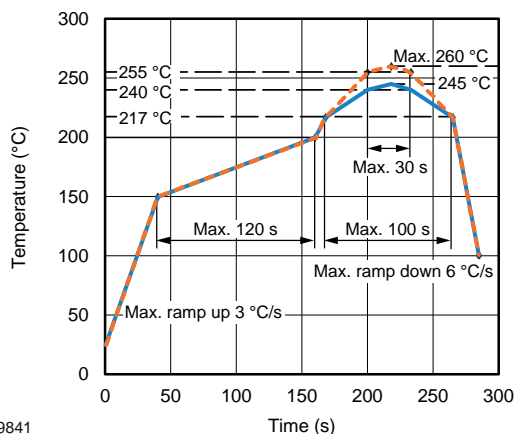


Fig. 5 - Lead (Pb)-free Reflow Solder Profile
According to J-STD-020 for SMD Devices

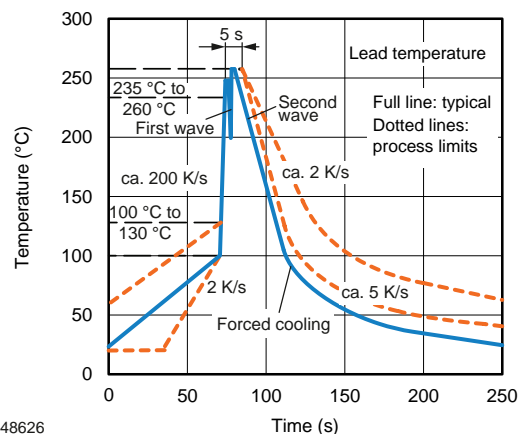


Fig. 6 - Wave Soldering Double Wave Profile
According to J-STD-020 for DIP Devices



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